

#### Maximum Ratings and Thermal Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

PARAMETE	SYMBOL	LIMIT	UNITS		
Drain-Source Voltage	V <sub>DS</sub>	60	- v		
Gate-Source Voltage		V <sub>GS</sub>			±20
Orantiana Drain Orana (Note 3)	Tc=25°C	168			
Continuous Drain Current <sup>(Note 3)</sup>	$T_{\rm C}=100^{\circ}{\rm C}$	l <sub>D</sub>	119	А	
Pulsed Drain Current <sup>(Note 1)</sup>	Tc=25°C	I <sub>DM</sub>	630		
Power Dissipation	Tc=25°C	D-	188	w	
	$T_{C}=100^{\circ}C$	Po	94		
Continuous Drain Current <sup>(Note 4)</sup>	T <sub>A</sub> =25°C	1_	21	Α	
	T <sub>A</sub> =70 <sup>°</sup> C	I <sub>D</sub>	18	А	
Power Dissipation	T <sub>A</sub> =25°C	Pp	3	W	
	T <sub>A</sub> =70 <sup>°</sup> C	PD	2.1		
Single Pulse Avalanche Current <sup>(Not</sup>	las	54	А		
Single Pulse Avalanche Energy <sup>(Note</sup>	Eas	162	mJ		
Operating Junction and Storage Te	TJ,TSTG	-55~175	°C		
Thermal Resistance <sup>(Note 4)</sup>	Junction to Case	R <sub>θJC</sub>	0.8	°C/W	
	Junction to Ambient	R <sub>0JA</sub>	50		



# PJD100N06SA-AU

#### Electrical Characteristics (TA=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static		·					
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	Vgs=0V, Id=250uA	60	-	-	V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250$ uA	1.5	2.1	3		
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	2.6	3.3		
Drain-Source On-State Resistance		V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A	- 3.9 5		5	mΩ	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V	-	-	1	uA	
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	-	-	±100	nA	
Dynamic <sup>(Note 6)</sup>							
Total Gate Charge	Qg		-	82	107	nC	
Gate-Source Charge	Qgs	$V_{DS}=30V, I_{D}=20A,$	-	14	-		
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	19	-		
Input Capacitance	Ciss		-	4728	6146	pF	
Output Capacitance	Coss	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V, f=1MHz	-	1508	1960		
Reverse Transfer Capacitance	Crss		-	72	-		
Gate resistance	Rg	f=1MHz	-	1.3	-	Ω	
Turn-On Delay Time	td <sub>(on)</sub>		-	13	-	ns	
Turn-On Rise Time	tr	V <sub>DS</sub> =30V, I <sub>D</sub> =20A,	-	26	-		
Turn-Off Delay Time	td <sub>(off)</sub>	$V_{GS}=10V, R_G=3\Omega$	-	66	-		
Turn-Off Fall Time	tf		-	37	-		
Drain-Source Diode							
Diode Forward Current	I <sub>S</sub>	Tc=25°C	-	-	168	A	
Pulsed Diode Forward Current	I <sub>SM</sub>	1c=25 C	-	-	630		
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =20A, V <sub>GS</sub> =0V	-	0.8	1.3	V	
Reverse Recovery Time	Trr	V <sub>DD</sub> =30V,V <sub>GS</sub> =0V	-	65	-	ns	
Reverse Recovery Charge	Qrr	Is=20A,dIs/dt=100A/us	-	73	-	nC	

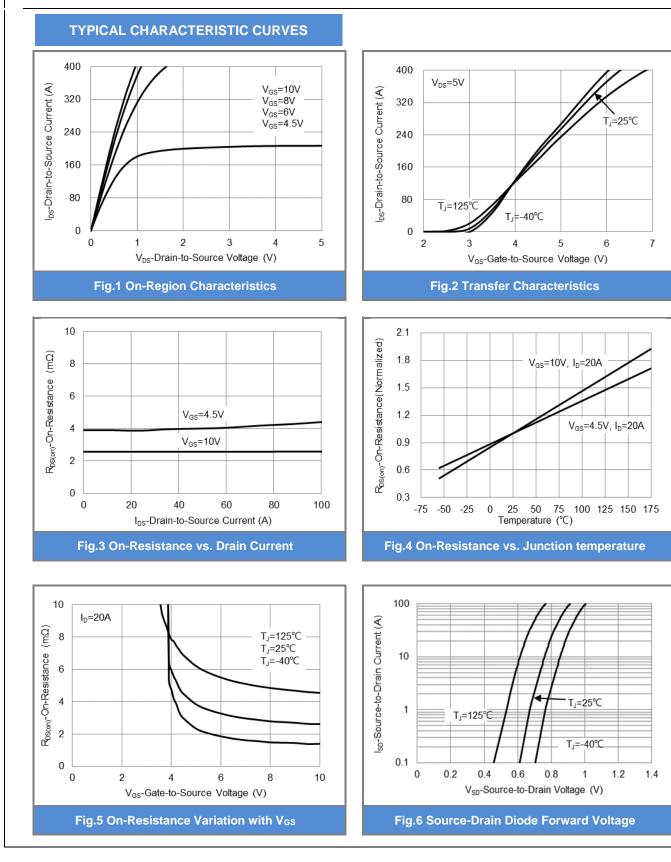
NOTES :

- 1. Pulse width100us, Duty cycle<2%.</td>
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Chip capability with an  $R_{\theta JC}=0.8^{\circ}C/W$ , Package limited 100A.
- 4.  $R_{\theta,JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch<sup>2</sup> with 2oz.square pad of copper.
- 5. E<sub>AS</sub> is calculated based on the condition of L=1mH, I<sub>AS</sub>=18A, V<sub>DD</sub>=30V, V<sub>GS</sub>=10V. 100% test at L=0.1mH, I<sub>AS</sub>=54A in production.
- 6. Guaranteed by design, not subject to production testing.

SEMI CONDUCTOR

PANJ

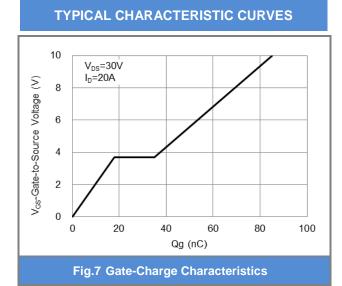
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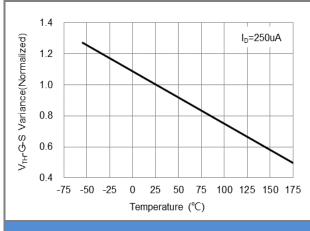


SEM CONDUCTOR

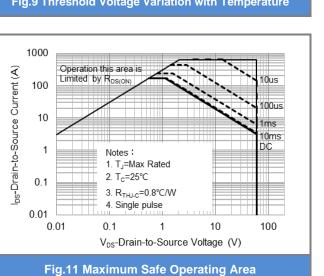
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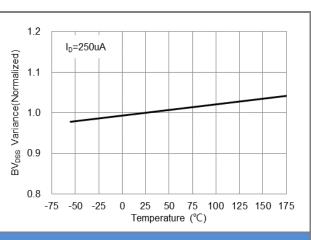
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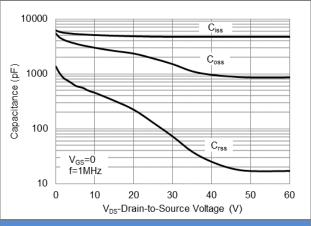




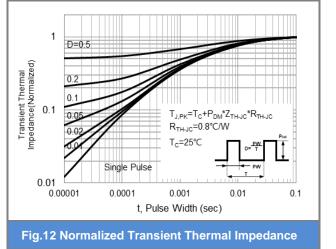












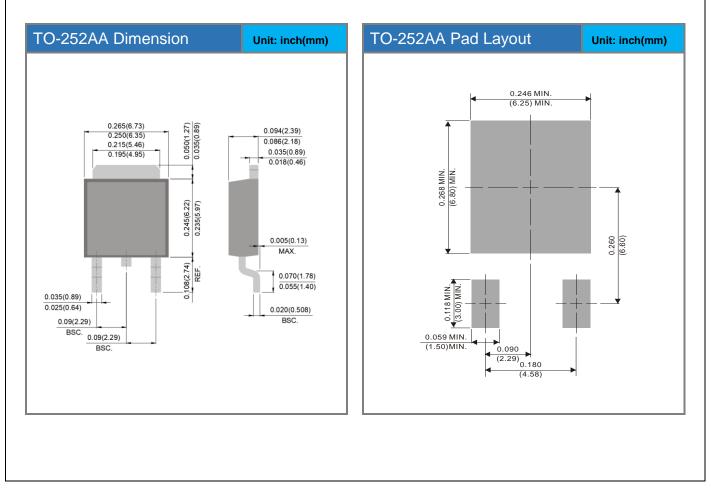


## PJD100N06SA-AU

#### **Product and Packing Information**

Part No.	Package Type	Packing Type	Marking	
PJD100N06SA-AU	TO-252AA	3K pcs / 13" reel	100N06SA	

#### Packaging Information & Mounting Pad Layout





## PJD100N06SA-AU

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